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Can a carbon nano-coating resist metallic phase transformation in silicon substrate during nanoimpact?

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Abstract: Nanomechanical response of a silicon specimen coated with a sp^3 crystalline carbon coating (1.8 nm thickness) was investigated using MD simulation. A sharp conical rigid tip was impacted at the speed of 50 m/sec up to a depth of ~80% of the coating thickness. Unlike pure silicon specimen, no metallic phase transformation was observed i.e. a thin coating was able to resist Si-I to Si-II metallic phase transformation signifying that the coating could alter the stress distribution and thereby the contact tribology of the substrate. The stress state of the system, radial distribution function and the load-displacement curve were all aligned with above observations¹.

Keywords: MD simulation; phase transformation; silicon; carbon; coating; nanoimpact

1. Introduction

High pressure phase transformation (HPPT), now known as the Herzfeld-Mott transition [1] causes metallization of brittle materials (group-IV elements) [2]. HPPT thus induces metal like behaviour because of the closure of the valence-conduction band gap due to overlap of wave functions and hence delocalization of the valence electrons [3]. An example of such a case is silicon, where during its contact loading (such as during nanoindentation, nanometric cutting and nanoimpact), a hydrostatic pressure of about 11-16 GPa [4] results in the transformation of the Si-I (cubic diamond structure) into a more dense metallic Si-II phase having a β -tin structure [5] of silicon. Recently, thin films are being frequently used as protective coatings - for instance, on magnetic and optical storage disks, optical windows, biomedical and micro/nano-electromechanical (MEMS/NEMS) devices [6]. Consequently, there is a growing interest on advancing the understanding on the nanomechanical behaviour of the films and the substrate. The objective of this work is inspired from recent experimental works [7-8] on thin films and is focused on supplementing those investigations by carrying out a theoretical investigation concerning the occurrence of high pressure phase transformation during nanoimpact in a silicon substrate which is coated by a pure crystalline sp^3 bonded carbon film. Phase transformation of brittle materials is of particular interest to the field of nanometric cutting because it provides the roadmap to obtain the ductile response from brittle materials [9]. An understanding of how high pressure phase transformation can be regulated is necessary to know to control the deviatoric stress conditions in order to drive or suppress ductile response of brittle materials such as during machining of silicon [9-10].

2. MD Model

In this work, molecular dynamics (MD) simulation is applied to study the nanomechanical response of a silicon specimen coated with a crystalline thin film of sp^3 carbon. The objective of this study was to

¹ Readers are requested to refer to the web based version for correct interpretation of the colour legends.

study a pure system to see the maximum theoretical limits of Young's modulus (E), therefore a pure sp^3 carbon film (and not an amorphous thin film) was chosen. The simulation was performed using LAMMPS [11] assuming the indenter tip to be a rigid body. Analytical bond order potential (ABOP) and reactive empirical bond order (REBO) potential functions were used to describe the covalent descriptions of silicon and carbon respectively [12]. The algorithm followed in this work is the same as has been used in the previous investigations [6, 13-14]. Additionally, an automated Dislocation Extraction Algorithm (DXA) [15-18] was also used to visualize and analyze the atomistic simulation data to identify dislocation lines. Additional trials were performed by varying the shape of the indenter (spherical and pyramidal) and depth of the indentation (performing indentation at depths less than 80% of the coating thickness) but the coating still resisted the Si-I to Si-II phase transformation in the substrate. For brevity, only one case is presented here where the thickness of the coating was about 1.8 nm, and the height and the diameter of the indenter were chosen as 1.8 nm and 2.7 nm respectively while the depth of impact was 1.5 nm at the speed of 50 m/sec. An MD simulation without involving any coating was also performed as a precursor to the main trial, and in the system without coating, the measure of coordination number and radial distribution function showed clear evidence of phase transformation of silicon (The results obtained from the simulation without coating are not reported for brevity) as is well known from the experiments and simulations [19].

3. Results and discussions

Figure 1 show the force-displacement ($P-h$) plot obtained from the MD simulation. The force variation shown in figure 1 relates to the deformation, cohesion and recovery of atoms. The plot has been divided into various stages shown in figure 1. Landman *et al.* [20-21] have highlighted that even when the atoms of the tip and the substrate are strained, they try to optimize their embedding energies while maintaining their individual material cohesive binding energies. This leads to a jump out contact in the $P-h$ plot represented as point B. As the indenter continues to move, a monotonic increase of forces can be seen until point C. At point C, few carbon-carbon bonds were observed to fracture in order to accommodate the indenter inside the coating. Due to the fracture of the thin coating at this point, the forces on the indenter decrease suddenly. However, after this point other C-C bonds were observed to stretch further which causes an increase in the forces on the indenter. This increase once again exhibited monotonic nature until point D where the forces were found to decrease. Simulation video showed that this sudden drop at point D was on account of the disturbances in the crystal lattice structure in the substrate. These were the major stages captured from the simulation during the loading stage of the indenter.

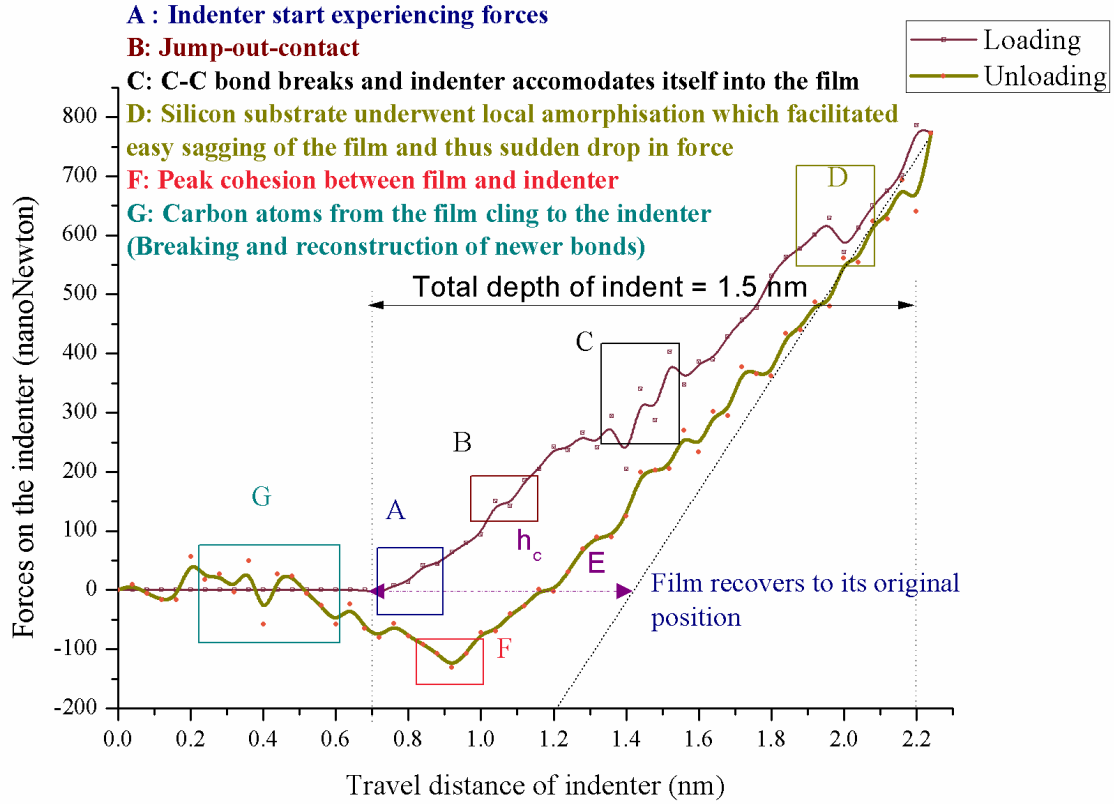


Figure 1: Force-displacement ($P-h$) curve obtained from the MD simulation

During unloading, the indenter retracts and consequently the force on the indenter decreases. During this stage, the carbon coating restores its original position until point E. Thereafter, cohesion between the carbon atoms of the coating and indenter tip becomes more pronounced. Consequently, cohesive forces attract the indenter towards the coating while the physical velocity of the indenter is in a direction opposite to that of the cohesive force. Relatively large retraction force of the indenter causes negative display of forces and a pronounced force hysteresis between point E and point F. At point F, as the indenter continues to retract, the cohesive bond length between the carbon atoms of the coating and the indenter stretches to its maximum limit. Beyond this point, the ultimate separation occurs when the inter-atomic distance between the last two bonded C-C atoms exceeds 1.75 \AA . Zavitsas *et al.* [22] assert that 1.75 \AA is the maximum possible bond length between two carbon atoms, which is consistent with the current simulation results. The force hysteresis therefore was found related to and originating from the cohesive dynamics between the carbon atoms of the coating and the diamond tip. Depending on the depth of the impact, energy transferred from the indenter to the coating and the stresses induced during the process may result in a backward (negative) depth deviation [6]. Further work in this direction can be referred elsewhere [6, 23].

Although a quantitative measure of separation distance of C-C bond provides confidence in the MD simulation, the authors also conducted an evaluation of the modulus of elasticity from the loading and unloading curve shown in figure 1. This was accomplished by applying the Oliver and Pharr method [24], which enables an estimation of the contact area directly from the $P-h$ curve without assessment of the actual contact area of the indenter. An imaginary line on the unloading curve was plotted by following the power law along the unloading curve on the top $1/3^{\text{rd}}$ part. The elastic modulus of the coating was obtained as 405 GPa (considering $h_c=0.924 \text{ nm}$ at $P_{max}=750 \text{ nN}$ and slope= 937.5 N/m). This theoretical value may be difficult to realize experimentally owing primarily to the differences such as sample roughness, air lubrication, sensitivity of the equipment, purity of the material, and accuracy of measurement which may influence the experimental results. However, by extrapolation in the modulus value to the zero depth as is done in ISO14577 seems to reveal the same

value of E for a pure sp^3 coating.

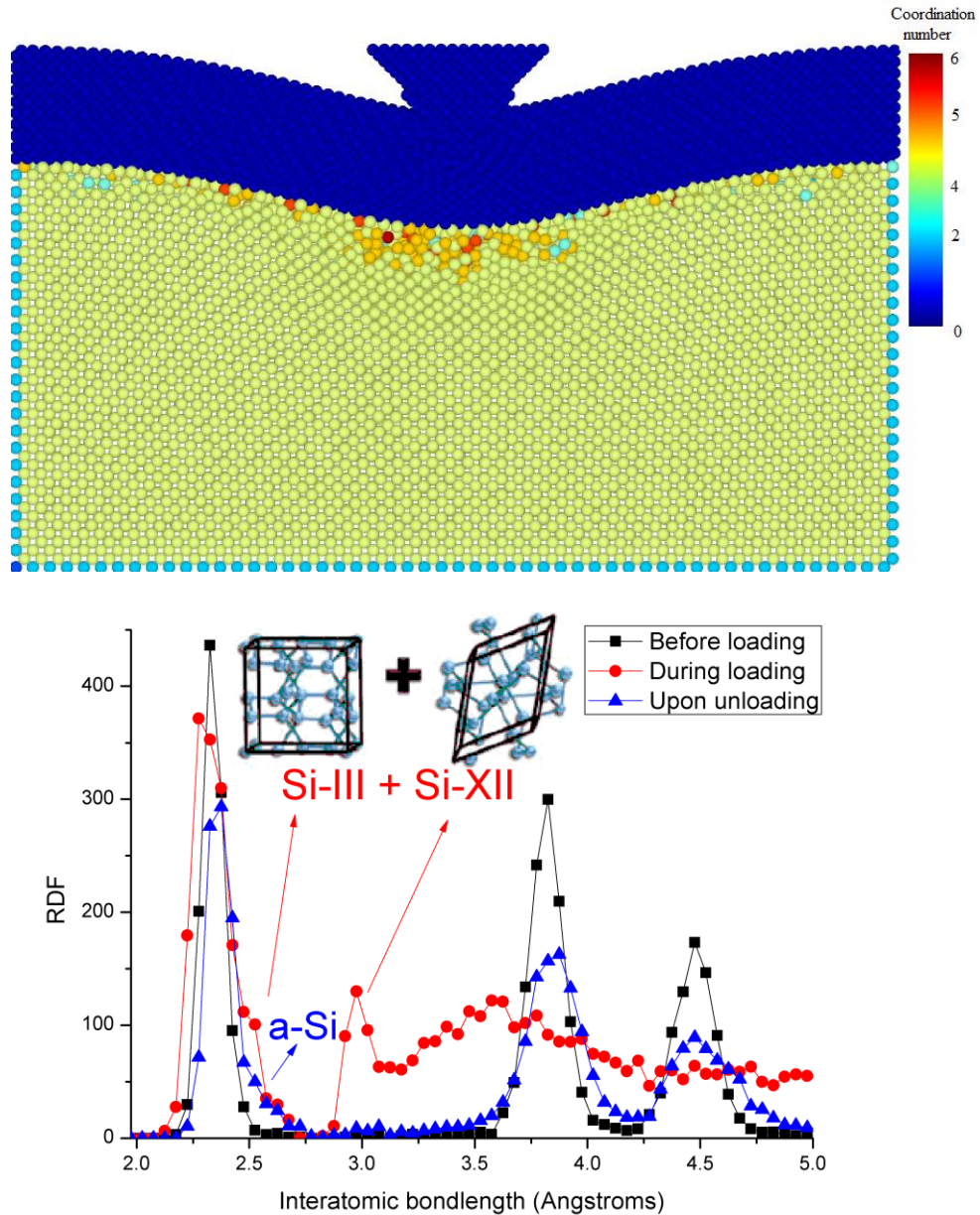


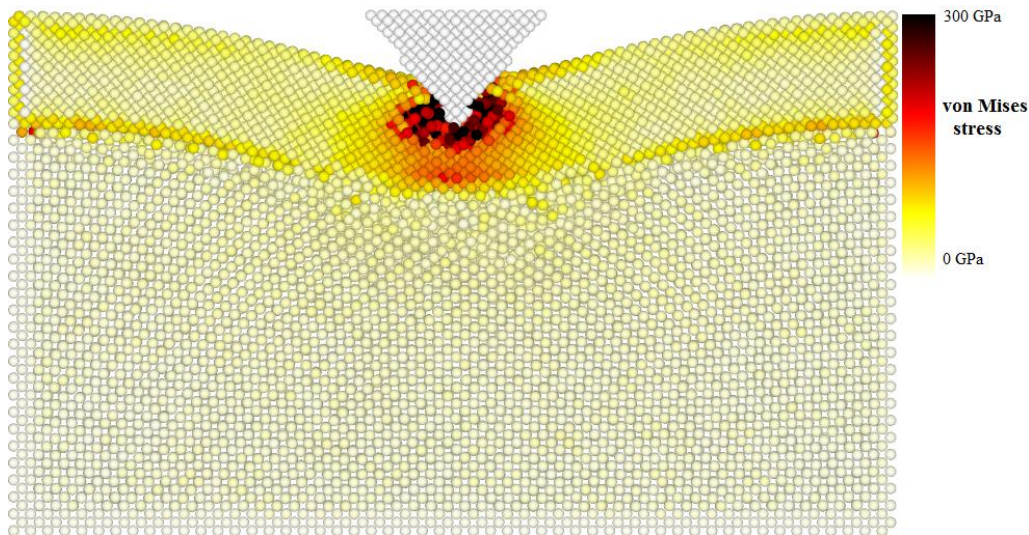
Figure 2: Changes in the crystal structure of silicon (a) variation in the coordination number of the silicon substrate. The coordination number of carbon was not calculated and therefore shown as zero (b) Local radial distribution function (RDF) of the silicon atoms in the substrate.

During loading stage, the material below the indenter compresses and consequently sagging of the coating becomes ostensibly visible. This brings a lot of lattice disorder in the carbon coating and also in the silicon substrate. Change in coordination number (which is a well identified measure to monitor phase transformation in crystalline materials [25]) and radial distribution functions were used to observe such changes and one such result is shown in figure 2a. It can be seen from figure 2a that the bulk of single crystal silicon has a coordination number of 4 which is indicative of a covalently bonded crystalline system in its stable diamond cubic lattice structure. Atoms with zero coordination value are the ones which were not included in the computation. In the deformation zone, a large number of atoms showed a coordination value of five. These data suggest that unlike classical contact loading of silicon,

metallic phase transformation leading to formation of β -silicon (6 coordination number) did not occur. This finding seems to be in line with several experimental observations [26-28], where no metallic phase of silicon (β -silicon) was found when a thin film on a substrate was indented. Since experimental and simulation results corroborate each other, the simulation size scale chosen in the current work seems insensitive to the MD simulation results.

To explore this even further, radial distribution function (RDF) of silicon was plotted at three stages i.e. before loading, during peak loading and after unloading (figure 2b). It can be seen that silicon exhibited additional peaks at around 2.5 Å and 3.0 Å during peak loading. These peaks (separately highlighted in red and blue colours) were different from the crystalline peaks (black colour). The state of the stress in the silicon substrate and the coordination number measurement in accordance with the radial distribution function support the assertion that the pristine silicon substrate underwent Si-III and Si-XII metastable phases and reverted to the amorphous mixture of silicon upon release of the indentation load rather than undergoing metallic phase transformation (Si-II).

This finding is in contrast to the case of a classical nanoindentation test where the metallic phase of β -silicon can immediately be observed upon indentation of a silicon substrate. While the existence of metastable phases can bring the structural changes in the crystal lattice described above, these may not be the only cause of the reduced elastic modulus of the carbon coating. It was based on these observations that conclusion was made by Haq *et al.* [28] that unlike classical nanoimpact, thin film acts as a barrier to promote sufficient magnitude of pressure at the film-substrate interface to drive the high pressure phase transformation (HPPT) of pristine silicon to metallic β -silicon. These observations also suggest strongly that non observation of metallic phase and appearance of amorphous silicon in MD simulation complements the experimental findings.



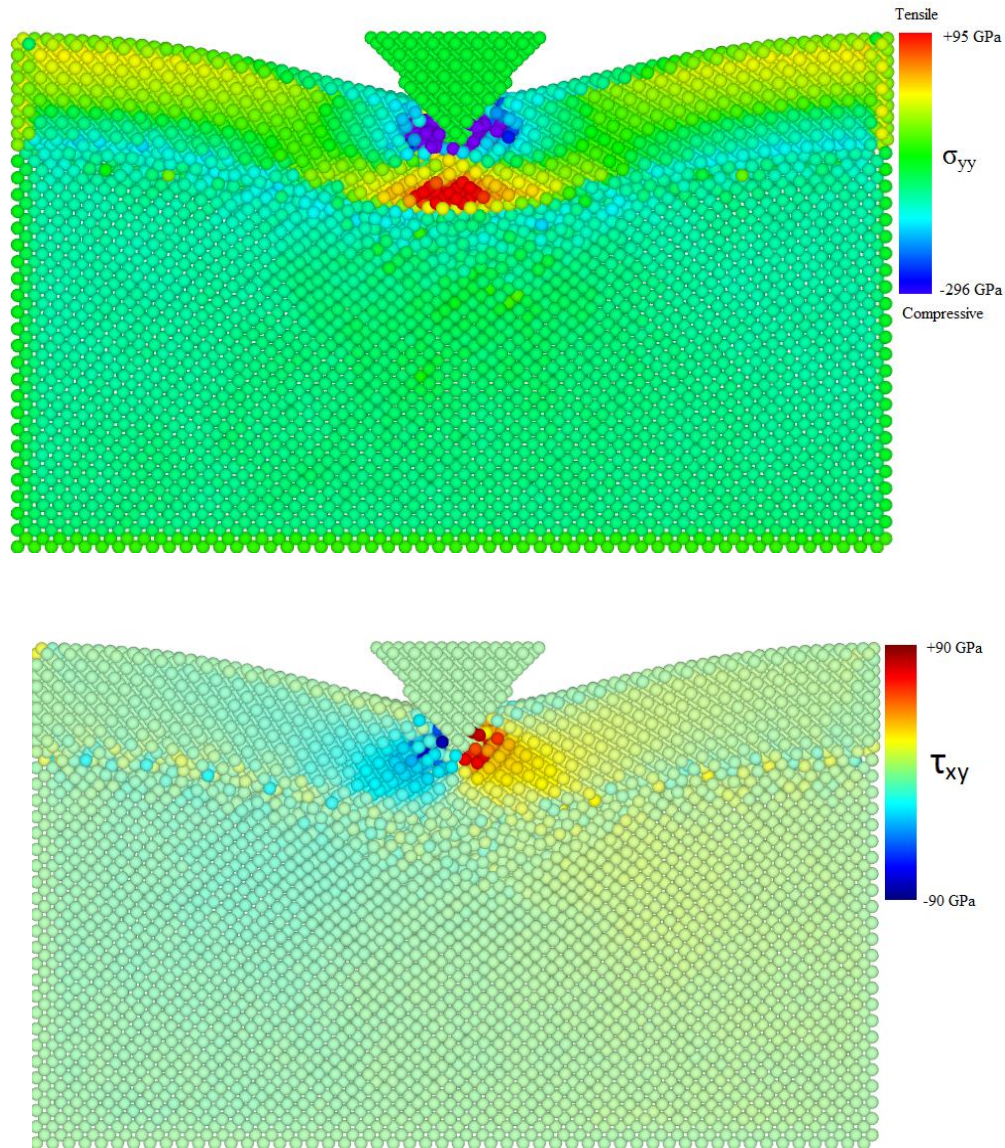


Figure 3: Representation of the atomic stresses: (a) von Mises stresses, (b) compressive stresses, and (c) shear stress.

To gain further insights into this phenomenon, stress states of atoms were obtained from the simulation. Figure 3 shows the von Mises stress, compressive stress and shear stress [29]. It can be seen from figure 3(a) that carbon atoms in the coating underwent local distortion and were subjected to peak von Mises stresses of up to 300 GPa involving the component of shear stress of up to 90 GPa. The interesting finding from the plot of compressive stress (figure 3(b)) is that the internal extreme layer of coating undergoes a compressive stress while the external extreme layer (near to the substrate) undergoes tensile stress. The classical theory of simple bending states that stress state remains compressive at any point above the imaginary neutral axis and tensile below the imaginary neutral axis when a beam undergoes a pure sagging moment. In line with this theory, it was observed that the internal extreme layer of coating showed a compressive stress of about -296 GPa while the external extreme layer showed a tensile stress of about 95 GPa. At peak loading, the peak von Mises stress in the silicon substrate was computed to be only about 10 GPa which is insufficient to cause metallic phase transformation of silicon as reported in the literature [4]. Gogotsi *et al.* [2, 30] have suggested that lack of sufficient stresses can activate other phases of silicon such as (Si-III which is a bc8 form of silicon) and Si-XII (which is a rhombohedral form). This transformation results in a volumetric reduction of the

atomic volume of silicon by about 10% and is in accordance with the observations revealed by RDF in figure 2b shown earlier.

To identify whether HPPT alone was the mechanism underneath the plastic behaviour or any dislocation motion was involved, an automated dislocation algorithm (DXA) [16-17] was used. Two snapshots were obtained from the dislocation analysis (figure 4): First at the peak loading stage and second after the unloading. At these stages during the impact, DXA did not show any nucleation of dislocation or dislocation lines. It is however possible that a number of other parameters like depth of impact, geometry of the probe, and speed of the impact may result in dislocation nucleation at other impact parameters. This will however not bring any change in the high pressure phases of the substrate.

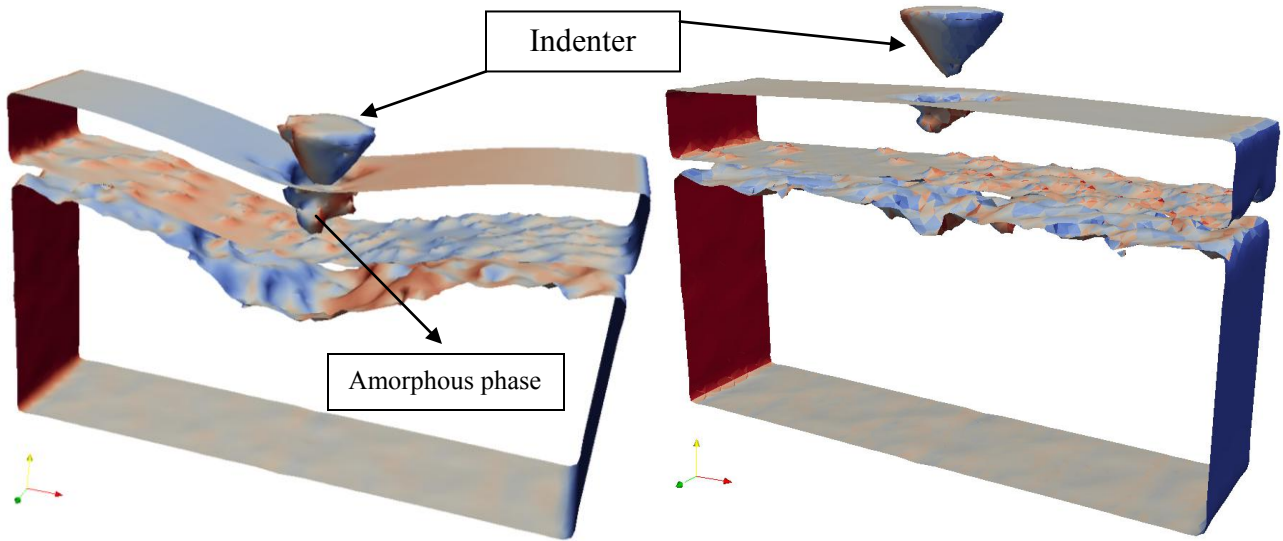


Figure 4: Output of the DXA algorithm (a) at peak loading and (b) unloading showing no dislocations. The geometric boundaries of silicon and coating are shown, while the geometric boundaries of the disordered phase are not visible in these visualizations

4. Conclusions

In summary, MD simulation shows that even a thin carbon coating (of several nanometer thickness) can change the contact tribology during nanoimpact. The physical existence of coating alters the deviatoric stress distributions on the silicon during the nanoimpact. The distribution of stresses over the entire surface area prevents concentration of the required magnitude of stresses right underneath the indenter. Consequently, no metallic phase transformation of silicon was observed and instead other phases of silicon such as Si-III and Si-XII were observed. Crucially, the changed contact tribology resulted in evenly distributed contact stresses and eventually resisted the metallic phase transformation in silicon during its nanoimpact, which is at variance with the results observed during nanoimpact of bulk silicon. This finding can stimulate future work on contact tribology of thin coatings.

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